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Mould for resin having good releasability - comprising fluororesin layer coated on moulding surface having opposite surface layer modified by UV radiation.

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JP 9193164	A	19970729	JP 969793	A	19960124	199740 B

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Patent Details:

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JP 9193164	A	4	B29C-033/38	

Abstract (Basic): JP 9193164 A

A mould for resin moulding comprises a fluororesin layer coated on the moulding surface (1a) facing a space (3) to be filled by a resin formed by a mould frame. The opposite face to a fluororesin article (6) along the moulding surface (1a) is a modified surface (6a) modified by UV ray radiation in the presence of a UV absorber and the modified surface is adhered to the moulding surface (1a) through an adhesive to form the fluororesin layer (A).

ADVANTAGE - The mould has high releasability of a moulded resin and high heat insulating property owing to the fluororesin surface interposed between the mould and the moulded resin. A moulded article without weld lines and flow marks etc. can be injection moulded for a long time using the mould.

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Derwent Class: A14; A26; A32

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